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8728-625 (YOR920030184US1)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: Howard Hao Chen et al. EXAMINER: Brook Kebede
SERIAL NO.: 10/661,299 GROUP ART UNIT: 2823
FILED: September 12, 2003
FOR: COOLING SYSTEM FOR A SEMICONDUCTOR DEVICE AND
METHOD OF FABRICATING SAME

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE TO RESTRICTION REQUIREMENT

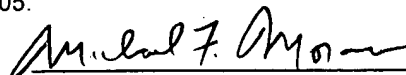
Sir:

This paper is submitted in response to the March 23, 2005 Office Action issued by the United States Patent and Trademark Office in connection with the above-identified application. A response to the March 23, 2005 Office Action is due on April 23, 2005. Therefore, this paper is being timely filed.

CERTIFICATE OF MAILING 37 C.F.R. § 1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postpaid in an envelope, addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on April 21, 2005.

Dated: April 21, 2005


Michael F. Morano

